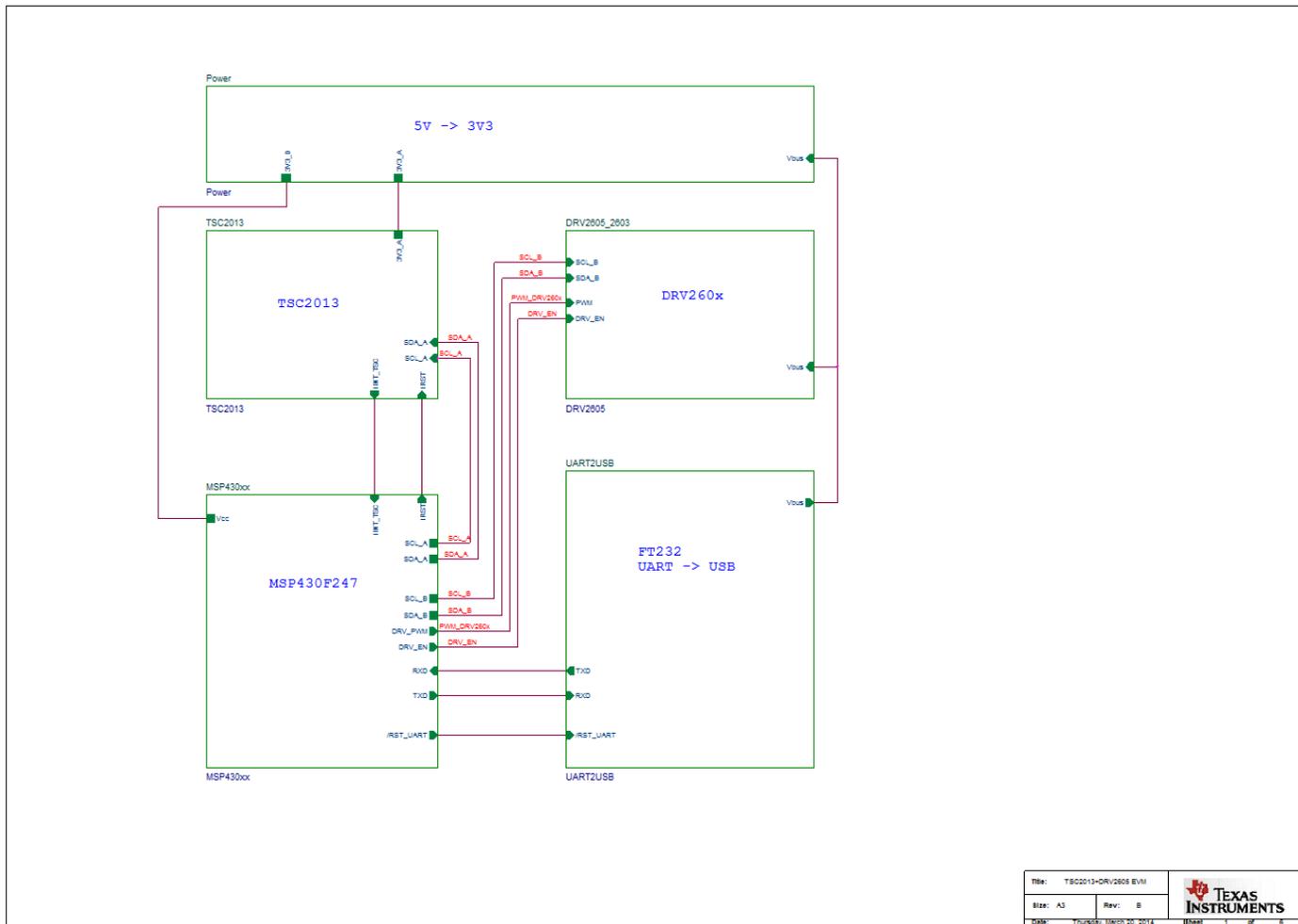


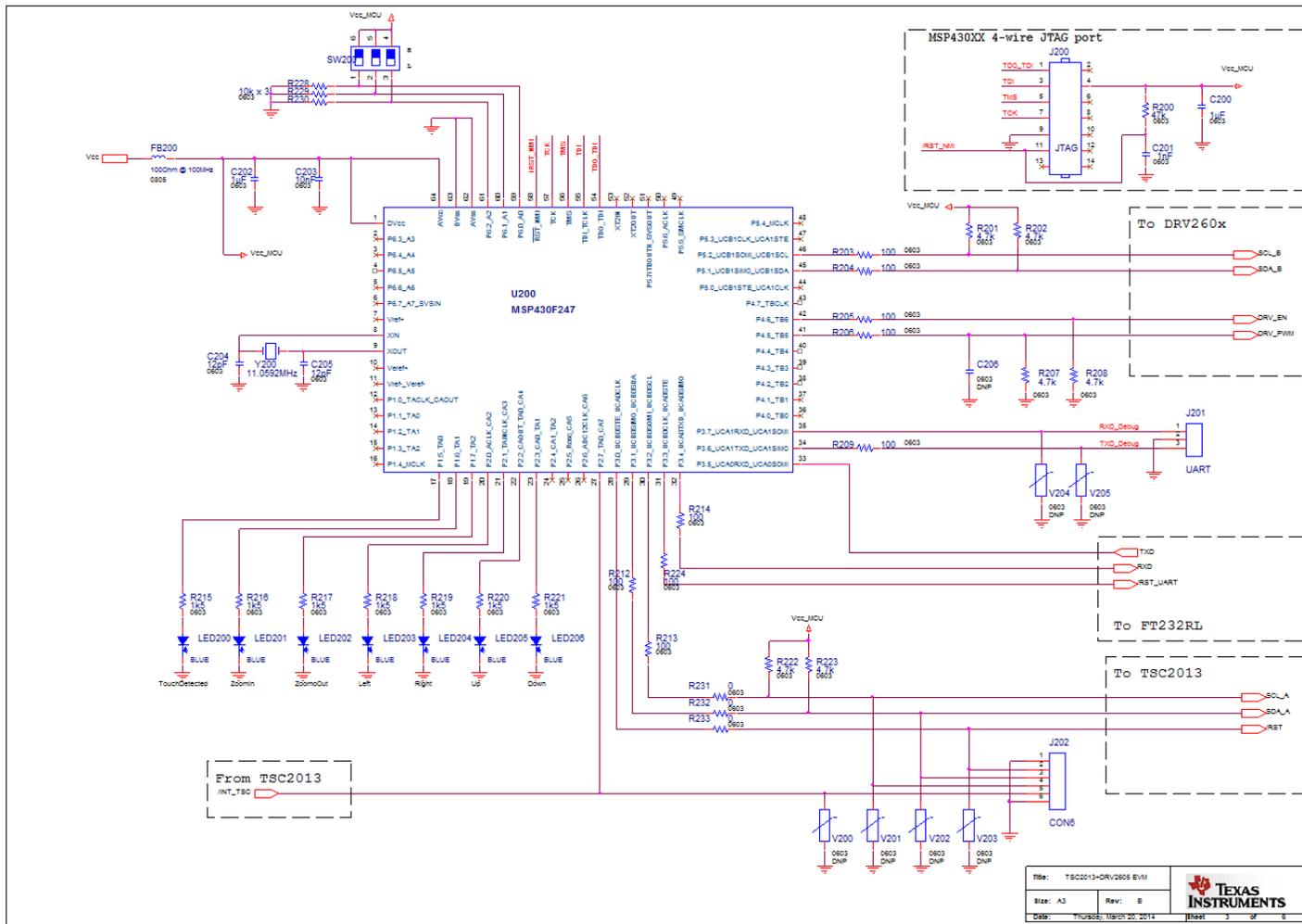
**TI Designs: Resistive Dual Touch Reference Board with Haptic Feedback for 4-wire Resistive Touch Panels**



Title: TSC2013-DRV2605 EVM		
Size: A3	Rev: 0	
DATE: TSC2013-03/20/2014		Sheet 1 of 6

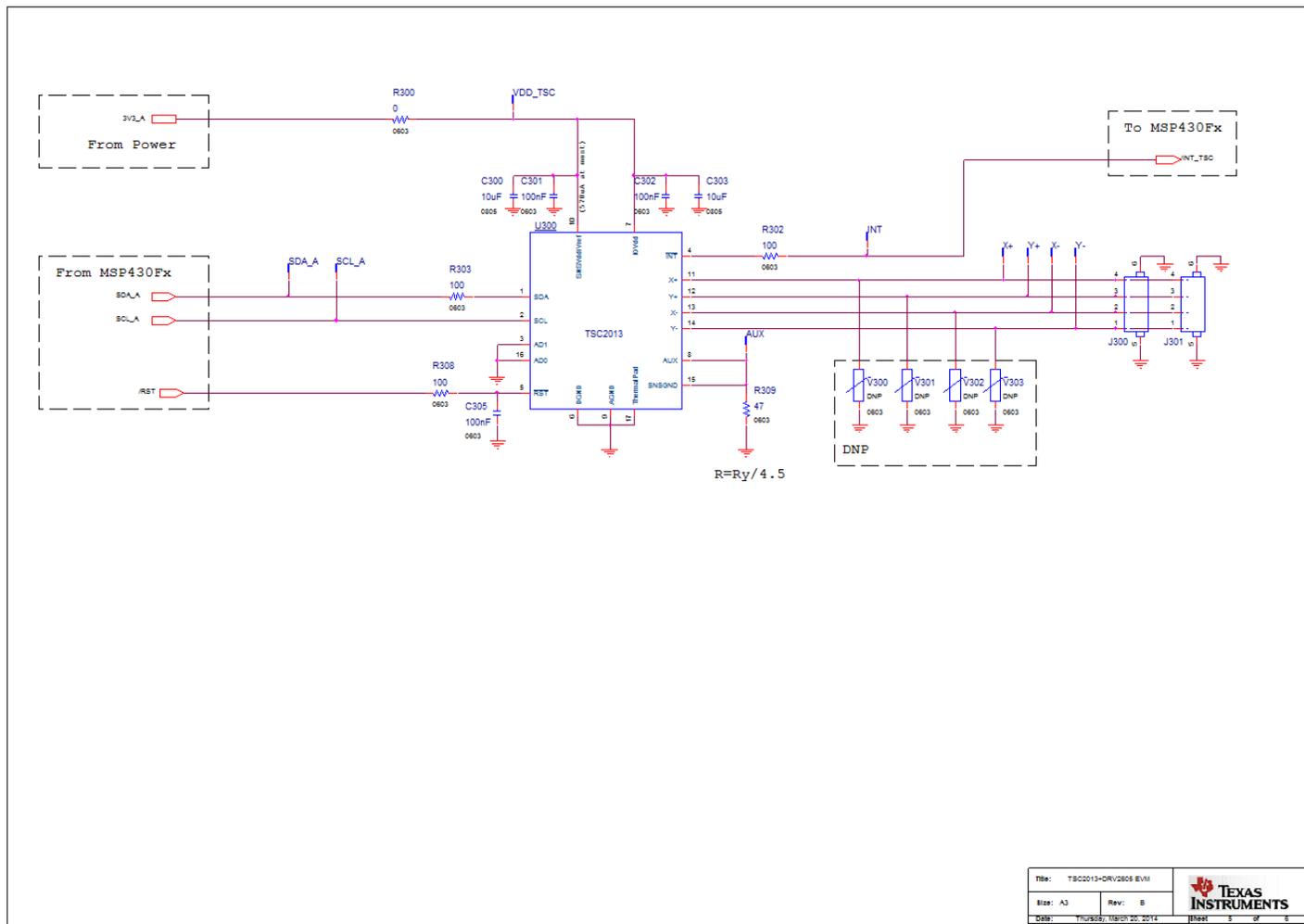
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# TI Designs: Resistive Dual Touch Reference Board with Haptic Feedback for 4-wire Resistive Touch Panels



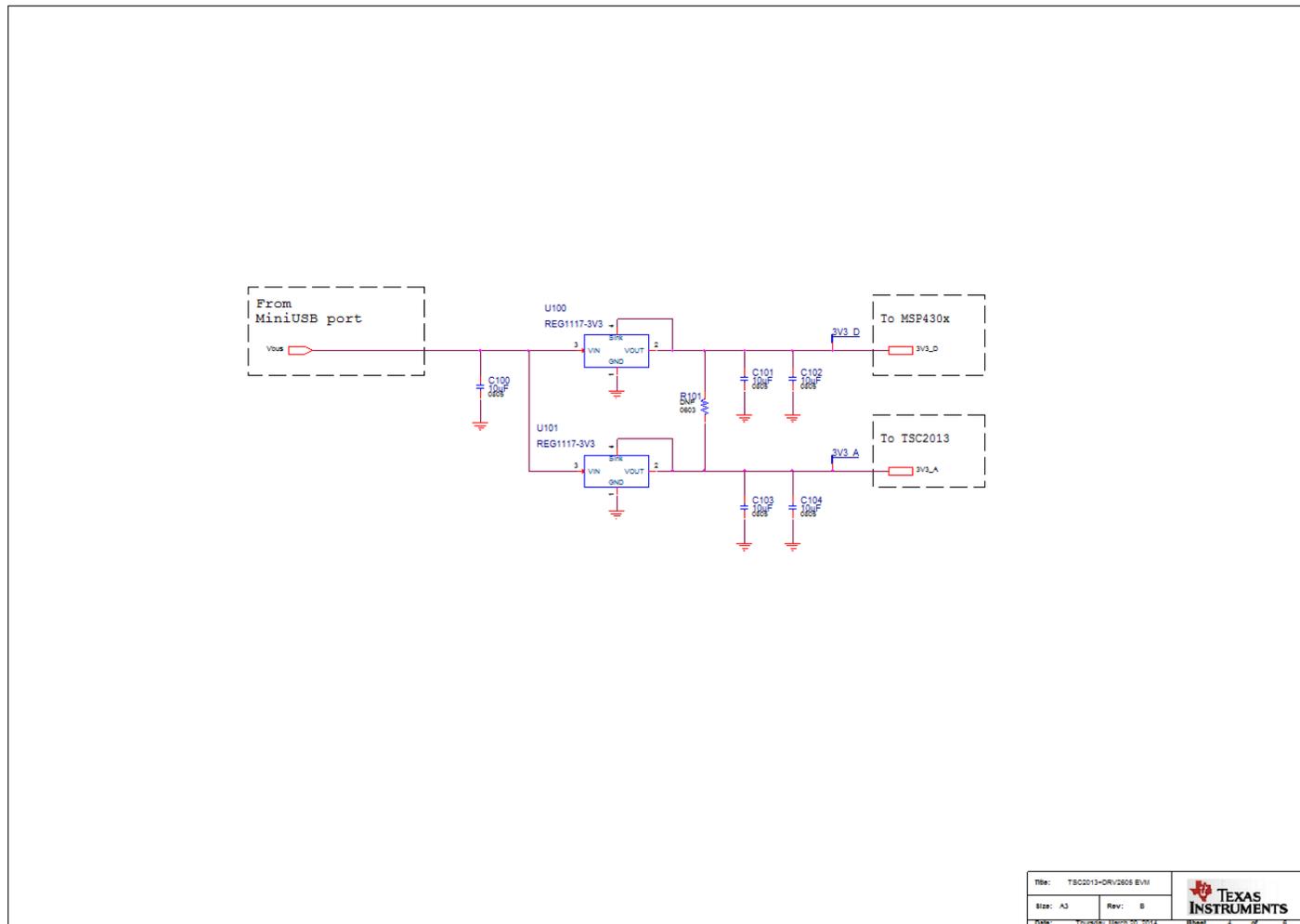
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## TI Designs: Resistive Dual Touch Reference Board with Haptic Feedback for 4-wire Resistive Touch Panels



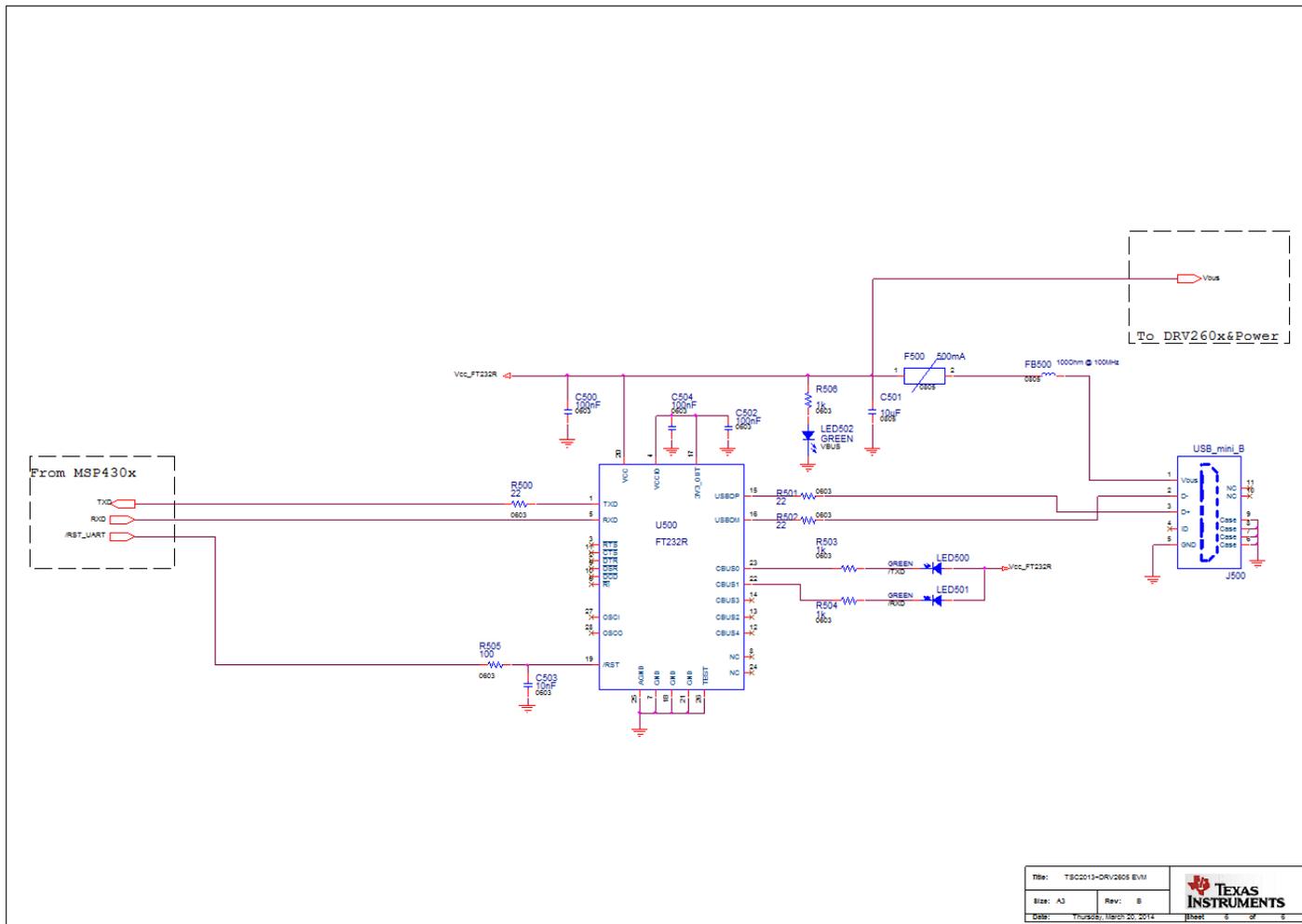
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## TI Designs: Resistive Dual Touch Reference Board with Haptic Feedback for 4-wire Resistive Touch Panels



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**TI Designs: Resistive Dual Touch Reference Board with Haptic Feedback for 4-wire Resistive Touch Panels**



Title: TSC015-DRV2605 EVM		
Size: A3	Rev: B	
Date: Y10002, 11/01/2014		

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